

Polypropylene Filament

SKU: FL105PP

Xtellar polypropylene filament is a next generation polypropylene (PP) filament designed to provide superior dimensional accuracy, inherently low density, high fatigue, and high moisture resistance for use in Fused Filament Fabrication (FFF). Additionally, this PP filament provides a balance of impact resistance and dimensional accuracy while enabling the production of watertight, lightweight and chemically resistant parts.

Recommended Print Settings

Parameter	Units	Range	
Extruder Temperature	°C	220 - 230	
*Recommended Bed Temperature / Substrate	°C / Type	60-80 / PP bed adhesion solution stick (water soluble)	
**Alternate Bed Temperature / Substrate	°C / Type	20-40 / Multi-purpose adhesive spray	
Printing Speed (First Layer)	mm/s	35 - 65 (60% speed)	
Fan Speed	%	50 - 100	
Extrusion Multiplier	_	0.90-1.10	
Overlap Percentage	%	20-40	
Brim	Layers	≥ 5	
Raft Air Gap	mm	0.1	

Printed Part Properties

Parameter	Method	Units	Value
Density	D 792	g/cm ³	0.89
Tensile Strength at Yield ^a	D 638	MPa	11
Tensile Elongation at Yield ^a	D 638	%	17
Youngs Modulus ^a	D 638	MPa	1020
Flexural Modulus – Chord Modulus ^a	D 790	MPa kJ/m²	840 11.7
Charpy Impact Strength at 23°C ^a	ISO 179		
Drop Impact Puncture Energy at 23°C	D 3763	D 3763 J	
Drop Impact Puncture Energy at 0°C	D 3763	J	4.2
Drop Impact Puncture Energy at −20°C	D 3763	J	1.1
Deflection Temperature (at 0.455 MPa)	D 648	°C	93
Vicat Softening Temperature (at 10 N)	D 1525	°C	130

Notes

1. Recommended process conditions and printed part properties may be changed at any moment without previous communication from Xtellar.

- 2. Printed part properties obtained using test specimens printed in X-Y direction under the following conditions: printing temperature 230°C, bed temperature 20°C (90°C first layer), print speed 20 mm/s, 100% of lines infill, 0 perimeter layers, 0.15 mm layer height, 0.4 mm brass nozzle.
- 3. Traditional bed adhesive solutions used for PLA & ABS (such as blue tape or hair spray) will not properly adhere PP, PE, or EVA to the build plate.
- 4. This resin does not contain the substance Bisphenol A (BPA, CAS: 80-05-7) in its composition.
- 5. For information on about safety, handling, individual protection, first aids and waste disposal, please see SDS.In case of questions regarding utilization or regulatory information, please contact our technical assistance area.

Xtellar does not guarantee printed part conditions, these represent estimated values based on internal test methods. Properties may vary based on print conditions.